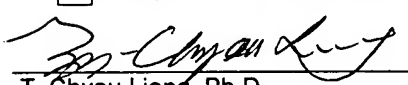




03-22-06

IFW

AMENDMENT TRANSMITTAL LETTER				Docket No. 07009/011003	
Application No. 10/670,812-Conf. #7754		Filing Date September 25, 2003		Examiner M. N. Trinh	
				Art Unit 3729	
Applicant(s): James Fraivilling					
Invention: BONDING OF A MULTI-LAYER CIRCUIT TO A HEAT SINK					
TO THE COMMISSIONER FOR PATENTS					
Transmitted herewith is an amendment in the above-identified application.					
The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	23	- 24 =		x	
Independent Claims	2	- 3 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00
<input type="checkbox"/> Large Entity <input checked="" type="checkbox"/> Small Entity					
<input checked="" type="checkbox"/> No additional fee is required for this amendment.					
<input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____. A duplicate copy of this sheet is enclosed.					
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.					
<input type="checkbox"/> Payment by credit card. Form PTO-2038 is attached.					
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>50-0591</u> as described below. A duplicate copy of this sheet is enclosed.					
<input checked="" type="checkbox"/> Credit any overpayment.					
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.					
 T. Chyau Liang, Ph.D. Attorney/Agent Reg. No.: 48,885				Dated: <u>March 21, 2006</u>	
OSHA · LIANG LLP 1221 McKinney St., Suite 2800 Houston, Texas 77010 (713) 228-8600					



Docket No.: 07009/011003
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
James Fraivilling

Application No.: 10/670,812

Confirmation No.: 7754

Filed: September 25, 2003

Art Unit: 3729

For: BONDING OF A MULTI-LAYER CIRCUIT
TO A HEAT SINK

Examiner: M. N. Trinh

RESPONSE TO RESTRICTION REQUIREMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the restriction requirement set forth in the Office Action mailed February 22, 2006, Applicant hereby elects Group I, claims 1-23, for continued examination without traverse. Claim 24 will be cancelled in due course.

The Examiner has required restriction between Group I, claims 1-23, drawn to Method for manufacturing PCB bonded to a heat sink, classified in class 29 subclass 832, and Group II, claims 24, drawn to apparatus, classified in class 174, subclass 255.

Application No.: 10/670,812

Docket No.: 07009/011003

Applicant believes no fee is due with this response. However, if a fee is due, please charge our Deposit Account No. 50-0591, under Order No. 07009/011003 from which the undersigned is authorized to draw.

Dated: March 21, 2006

Respectfully submitted,

By 

T. Chyau Liang, Ph.D.

Registration No.: 48,885

OSHA · LIANG LLP

1221 McKinney St., Suite 2800

Houston, Texas 77010

(713) 228-8600

(713) 228-8778 (Fax)



Application No. (if known): 10/670,812

Attorney Docket No.: 07009/011003

Certificate of Express Mailing Under 37 CFR 1.10

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail, Airbill No. EV766456829US in an envelope addressed to:

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

on March 21, 2006
Date

Signature

Ava R. Brown

Typed or printed name of person signing Certificate

Registration Number, if applicable

(713) 228-8600
Telephone Number

Note: Each paper must have its own certificate of mailing, or this certificate must identify each submitted paper.

Amendment Transmittal (1 page)
Response to Restriction Requirement (2 pages)